

Notification of Qualification of Die Thickness Update for LT8638S

Thermal Analysis Summary LT8638S

PCB:	4L Demo Board				
Device:	LT8638S	T_{ambient} (°C) =			
Die thickness (mm)	Die	P_{loss} (W)	θ_{JA} (K/W)	θ_{JCtop} (K/W)	θ_{JCbot} (K/W)
0.2	U1	1	15.80	31.20	3.20
0.45			15.42	14.70	2.70
	Total Power:	1			